

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application of: John Commander, et al.

Art Unit: 1753

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SEMICONDUCTOR APPLICATIONS

Examiner: Edna Wong

October 15, 2007

AMENDMENT K AFTER FINAL

In response to the Office action of October 9, 2007, please consider the following amendments and remarks.

Amendments to the claims are reflected in the listing of the claims that begins on page 2 of this paper.

Remarks begin on page 7 of this paper.

Conclusion begins on page 10 of this paper.

Ok to enter. W 10/19/07